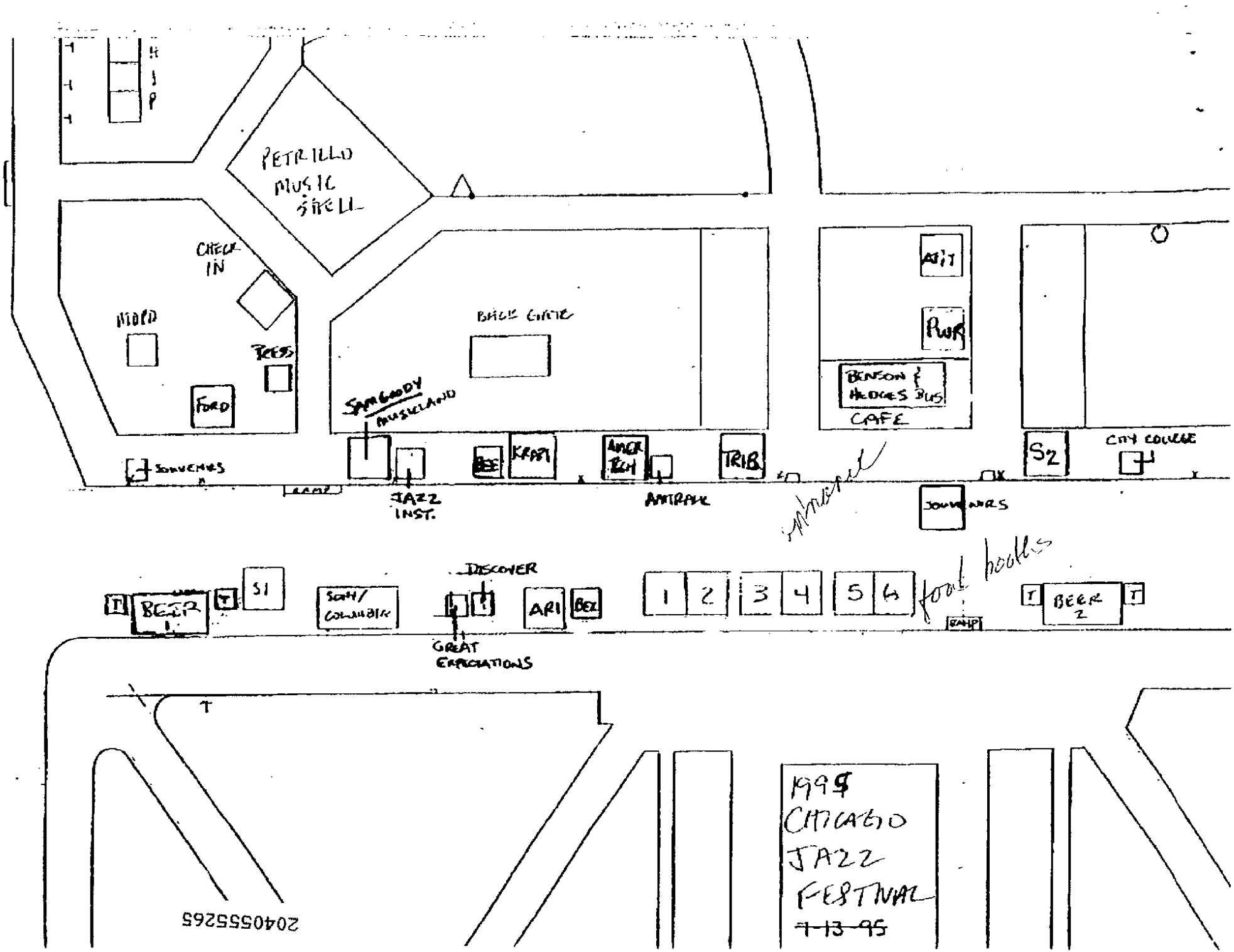Source: https://www.industrydocuments.ucsf.edu/docs/kxgm0004